

Octal bus transceiver/register; 3-state**74LVC646****FEATURES**

- Wide supply voltage range of 1.2 V to 3.6 V
- In accordance with JEDEC standard no. 8-1A.
- Inputs accept voltages upto 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Flow-through pin-out architecture

DESCRIPTION

The 74LVC646 is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The 74LVC646 consist of 8 non-inverting bus transceiver circuits with 3-state outputs, D-type flip-flops and control circuitry arranged for multiplexed transmission of data directly from the internal registers. Data on the 'A' or 'B' bus will be clocked in the internal registers, as the appropriate clock (CP_{AB} or CP_{BA}) goes to a HIGH logic level. Output enable (\overline{OE}) and direction (DIR) inputs are provided to control the transceiver function. In the transceiver mode, data present at the high-impedance port may be stored in either the 'A' or 'B' register, or in both. The select source inputs (S_{AB} and S_{BA}) can multiplex stored and real-time (transparent mode) data. The direction (DIR) input determines which bus will receive data when \overline{OE} is active (LOW). In the isolation mode (\overline{OE} = HIGH), 'A' data may be stored in the 'B' register and/or 'B' data may be stored in the 'A' register. When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, 'A' or 'B' may be driven at a time.

The '646' is functionally identical to the '648', but has non-inverting data paths.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; t_r = t_f ≤ 2.5 ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	propagation delay A _n , B _n to B _n , A _n	C _L = 50 pF V _{CC} = 3.3 V	4.7	ns
f _{max}	maximum clock frequency		150	MHz
C _i	input capacitance		5.0	pF
C _{IO}	input/output capacitance		10	pF
C _{PD}	power dissipation capacitance per latch	notes 1 and 2	35	pF

Notes to the quick reference data

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:
 f_i = input frequency in MHz; C_L = output load capacity in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.
2. The condition is V_i = GND to V_{CC}.

ORDERING INFORMATION

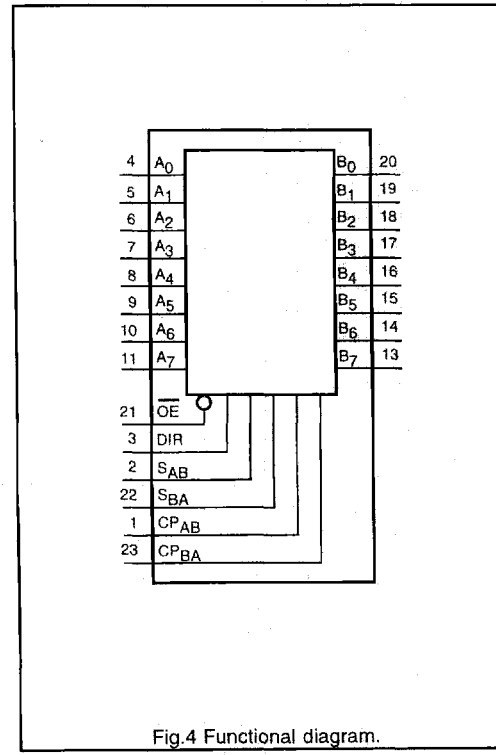
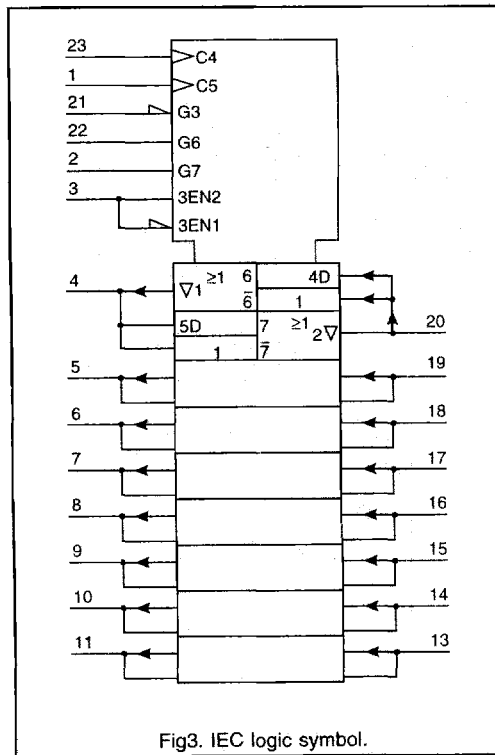
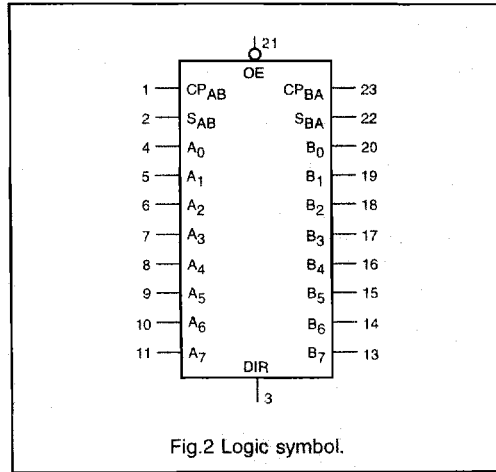
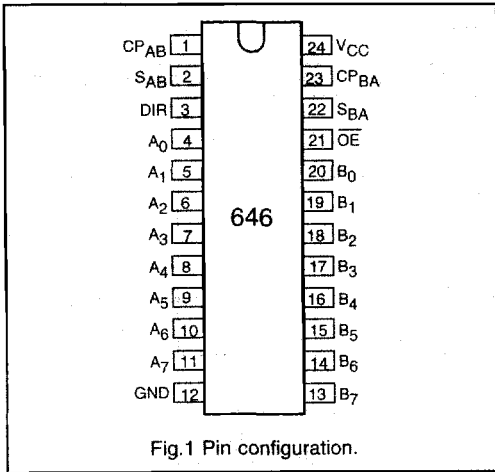
TYPE NUMBER	PACKAGE			
	PINS	PACKAGE	MATERIAL	CODE
74LVC646D	24	SO	plastic	SOT137-1
74LVC646DB	24	SSOP	plastic	SOT340-1
74LVC646PW	24	TSSOP	plastic	SOT355-1

PINNING

PIN	SYMBOL	NAME AND FUNCTION
1	CP _{AB}	'A' to 'B' clock input (Low-to-High, edge-triggered)
2	S _{AB}	select 'A' to 'B' source input
3	DIR	direction control input
4, 5, 6, 7, 8, 9, 10, 11	A ₀ to A ₇	'A' data inputs/outputs
12	GND	ground (0 V)
20, 19, 18, 17, 16, 15, 14, 13	B ₀ to B ₇	'B' data inputs/outputs
21	\overline{OE}	output enable input (active LOW)
22	S _{BA}	select 'B' to 'A' source input
23	CP _{BA}	'B' to 'A' clock input (Low-to-High, edge-triggered)
24	V _{CC}	positive supply voltage

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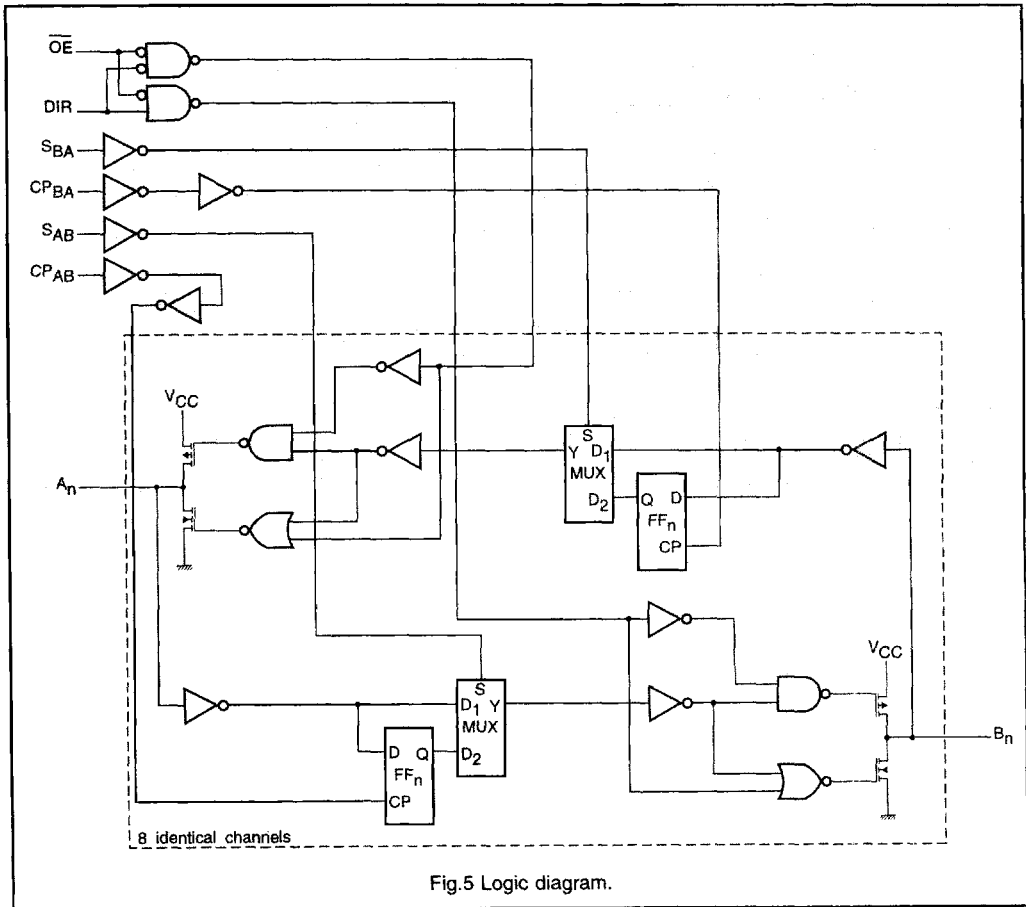


Fig.5 Logic diagram.

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FUNCTION TABLE

INPUTS						DATA I/O *		FUNCTION
\overline{OE}	DIR	CP _{AB}	CP _{BA}	S _{AB}	S _{BA}	A ₀ to A ₇	B ₀ to B ₇	
X	X	↑	X	X	X	input	un*	store A, B unspecified*
X	X	X	↑	X	X	un*	input	store B, A unspecified*
H	X	↑	↑	X	X	input	input	store A and B data, isolation
H	X	H or L	H or L	X	X			hold storage
L	L	X	X	X	L	output	input	real-time B data to A bus
L	L	X	H or L	X	H			stored B data to A bus
L	H	X	X	L	X	input	output	real-time A data to B bus
L	H	H or L	X	H	X			stored A data to B bus

* The data output functions may be enabled or disabled by various signals at the \overline{OE} and DIR inputs. Data input functions are always enabled, i.e., data at

the bus inputs will be stored on every LOW-to-HIGH transition on the clock inputs.

un = unspecified
 H = HIGH voltage level
 L = LOW voltage level
 X = don't care
 ↑ = LOW-to-HIGH level transition

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DC CHARACTERISTICS FOR 74LVC646

For the DC characteristics see chapter "LVC family characteristics", section "Family specifications".

AC CHARACTERISTICS FOR 74LVC646GND = 0 V; $t_r = t_f \leq 2.5$ ns; $C_L = 50$ pF

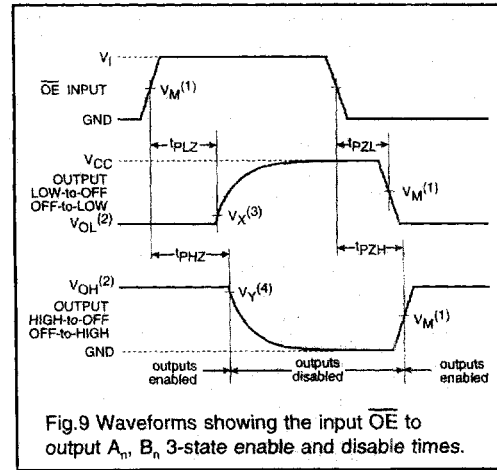
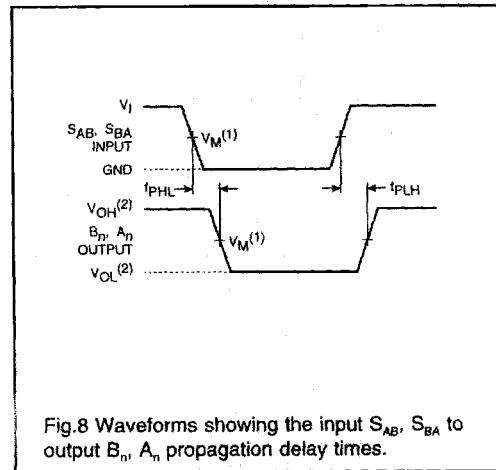
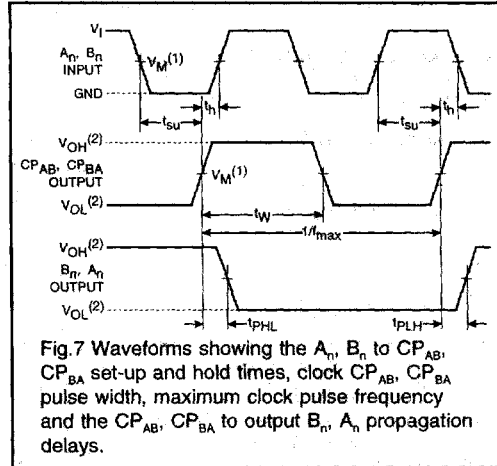
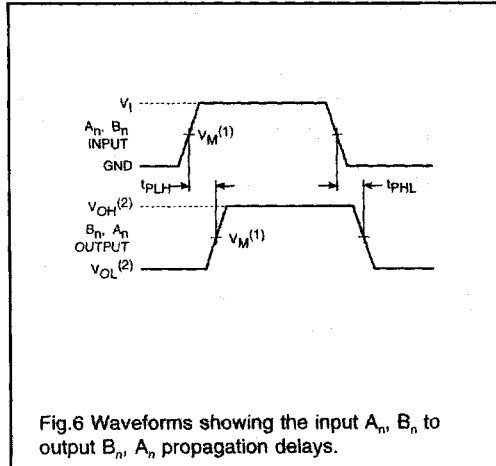
SYMBOL	PARAMETER	T_{amb} (°C)			UNIT	TEST CONDITIONS	
		-40 to +85				V_{CC} (V)	WAVEFORMS
		MIN.	TYP.	MAX.			
t_{PHL}/t_{PLH}	propagation delay A_n, B_n to B_n, A_n	1.5 1.5 1.5	24 5.2 4.6*	– 9.2 7.9	ns	1.2 2.7 3.0 to 3.6	Figs 6, 11
t_{PHL}/t_{PLH}	propagation delay CP_{AB}, CP_{BA} to B_n, A_n	1.5 1.5 1.5	26 6.0 5.2*	– 11 8.9	ns	1.2 2.7 3.0 to 3.6	Figs 7, 11
t_{PHL}/t_{PLH}	propagation delay S_{AB}, S_{BA} to B_n, A_n	1.5 1.5 1.5	27 6.4 5.2*	– 11 8.8	ns	1.2 2.7 3.0 to 3.6	Figs 8, 11
t_{PZH}/t_{PZL}	3-state output enable time \overline{OE} to A_n, B_n	1.5 1.5 1.5	21 5.3 4.8*	– 9.5 8.5	ns	1.2 2.7 3.0 to 3.6	Figs 9, 11
t_{PHZ}/t_{PLZ}	3-state output disable time \overline{OE} to A_n, B_n	1.5 1.5 1.5	16 4.3 4.0*	– 7.5 6.5	ns	1.2 2.7 3.0 to 3.6	Figs 9, 11
t_{PZH}/t_{PZL}	3-state output enable time DIR to A_n, B_n	1.5 1.5 1.5	21 5.3 4.8*	– 9.5 8.5	ns	1.2 2.7 3.0 to 3.6	Figs 10, 11
t_{PHZ}/t_{PLZ}	3-state output disable time DIR to A_n, B_n	1.5 1.5 1.5	16 4.3 4.0*	– 7.5 6.5	ns	1.2 2.7 3.0 to 3.6	Figs 10, 11
t_W	clock pulse width HIGH or LOW CP_{AB} or CP_{BA}	– –	3.0 3.0*	– –	ns	2.7 3.0 to 3.6	Figs 6, 8
t_{SU}	set-up time A_n, B_n to CP_{AB}, CP_{BA}	1.5 1.5	0.5 0.5*	– –	ns	2.7 3.0 to 3.6	Fig.7
t_H	hold time A_n, B_n to CP_{AB}, CP_{BA}	1.0 1.0	0 0*	– –	ns	2.7 3.0 to 3.6	Fig.7
f_{max}	maximum clock pulse frequency	– 75	– 150*	– –	ns	2.7 3.0 to 3.6	Fig.7

Notes: All typical values are measured at $T_{amb} = 25$ °C.* Typical values are measured at $V_{CC} = 3.3$ V.

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AC WAVEFORMS



- Notes:**
- (1) $V_M = 1.5 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_M = 0.5 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
 - (2) V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load
 - (3) $V_X = V_{OL} + 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_X = V_{OL} + 0.1 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
 - (4) $V_Y = V_{OH} - 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_Y = V_{OH} - 0.1 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$

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AC WAVEFORMS (Continued)

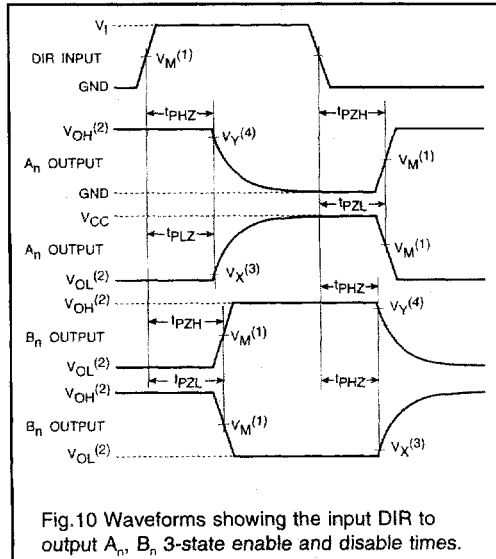


Fig.10 Waveforms showing the input DIR to output A_n, B_n 3-state enable and disable times.

- Notes:
- (1) $V_M = 1.5 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_M = 0.5 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
 - (2) V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load
 - (3) $V_X = V_{OL} + 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_X = V_{OL} + 0.1 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
 - (4) $V_Y = V_{OH} - 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
 $V_Y = V_{OH} - 0.1 \cdot V_{CC}$ at $V_{CC} < 2.7 \text{ V}$

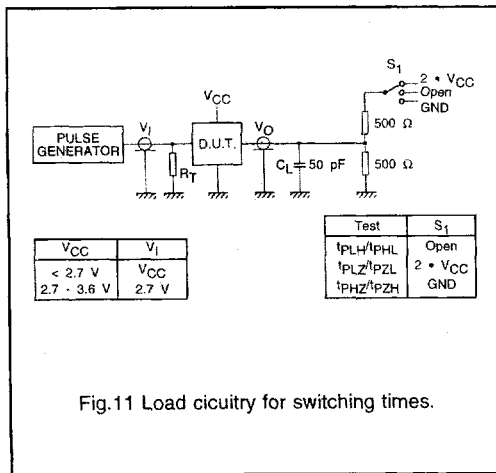


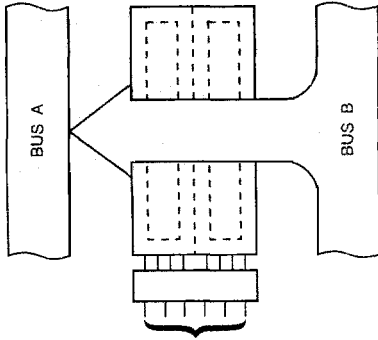
Fig.11 Load circuitry for switching times.

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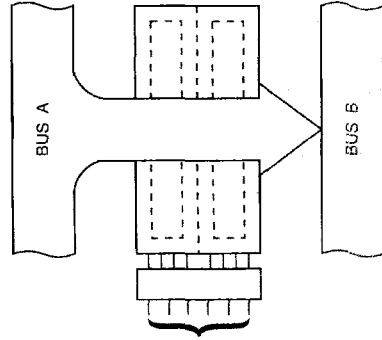
APPLICATION INFORMATION

Real-time transfer; bus B to bus A



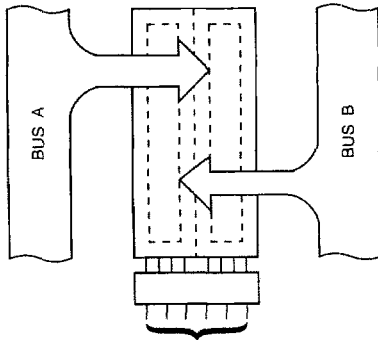
(1)	(14)	(28)	(16)	(27)	(15)
\overline{OE}	DIR	CP _{AB}	CP _{BA}	S _{AB}	S _{BA}
L	L	X	X	X	L

Real-time transfer; bus A to bus B



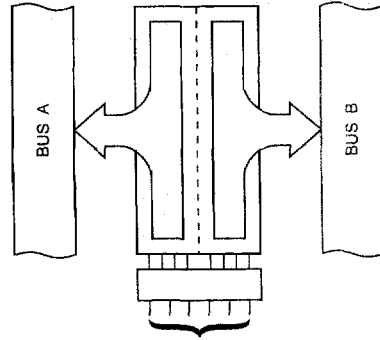
(1)	(14)	(28)	(16)	(27)	(15)
\overline{OE}	DIR	CP _{AB}	CP _{BA}	S _{AB}	S _{BA}
L	H	X	X	L	X

Storage from A, B or A and B



(1)	(14)	(28)	(16)	(27)	(15)
\overline{OE}	DIR	CP _{AB}	CP _{BA}	S _{AB}	S _{BA}
X	X	↑	X	X	X
X	X	X	↑	X	X
H	X	↑	↑	X	X

Transfer storage data to A or B



(1)	(14)	(28)	(16)	(27)	(15)
\overline{OE}	DIR	CP _{AB}	CP _{BA}	S _{AB}	S _{BA}
L	L	X	H or L	X	H
L	H	H or L	X	H	X